# GP1S036HEZ

Phototransistor Output, **Transmissive Photointerrupter** with Tilt Direction (4-direction) Detecting



#### Description

GP1S36J0000F is a compact-package, phototransistor output, transmissive photointerrupter, with opposing emitter and detector in a molding that provides a ball built-in case sensing. The compact package series is a result of unique technology combing transfer and injection molding.

This is a 2-phase output device, suitable for detection of the position (4 direction).

#### Features

- 1. Transmissive with phototransistor output
- 2. Highlights :
  - Built-in a ball (2 phase output)
  - Compact
  - PWB mounting type
  - 4-direction detection
- 3. Lead free and RoHS directive compliant

#### Agency approvals/Compliance

1. Compliant with RoHS directive

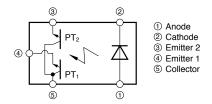
#### Applications

- 1. General purpose detection of device direction.
- 2. Example : Camera, DSC, Camcorder, Robot

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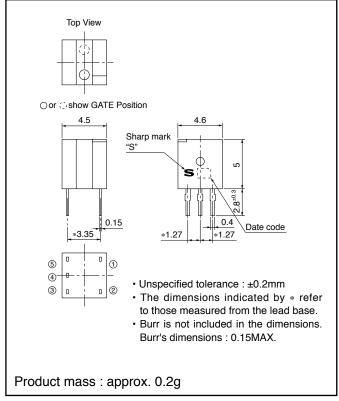


#### ■ Internal Connection Diagram



#### Outline Dimensions





Plating material : SnCu (Cu : TYP. 2%)

## SHARP

#### Date code (2 digit)

1st o	digit	2nd digit			
	production	Month of production			
A.D.	Mark	Month	Mark		
2000	0	1	1		
2001	1	2	2		
2002	2	3	3		
2003	3	4	4		
2004	4	5	5		
2005	5	6	6		
2006	6	7	7		
2007	7	8	8		
2008	8	9	9		
2009	9	10	Х		
2010	0	11	Y		
:	:	12	Z		

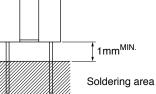
repeats in a 10 year cycle

Country of origin Japan, China

### SHARP

## Absolute Maximum Ratings

	Parameter		Rating	Unit	_
	Forward current	I <sub>F</sub>	50	mA	
Input	Reverse voltage	V <sub>R</sub>	6	V	
	Power dissipation	Р	75	mW	-
	Collector-emitter voltage	V <sub>CE10</sub>	35	V	-
		V <sub>CE20</sub>		•	_
Output	Emitter-collector voltage	V <sub>E1CO</sub>	6	v	
Output		V <sub>E2CO</sub>	0	v	
	Collector current	I <sub>C</sub>	20	mA	_
	Collector power dissipation	P <sub>C</sub>	75	mW	
Total	Total power dissipation		100	mW	
Opera	Operating temperature		-25 to +85	°C	
Storag	Storage temperature		-40 to +100	°C	
*1Solde	* <sup>1</sup> Soldering temperature		260	°C	



\*1 For MAX. 5s

#### ■ Electro-optical Characteristics

■ Electro-optical Characteristics (T <sub>a</sub> =25°C								
	Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input	Forward voltage		$V_{\rm F}$	I <sub>F</sub> =20mA	-	1.2	1.4	V
Input	Reverse current		I <sub>R</sub>	V <sub>R</sub> =3V	-	-	10	μA
*3Output	Dark current		I <sub>CEO</sub>	V <sub>CE</sub> =20V	-	-	100	nA
	Collector current		I <sub>C</sub>	$V_{CE}=5V, I_{F}=5mA$	55	-	300	μA
* <sup>3</sup> Transfer	*4Leak current		I <sub>LEAK</sub>	V <sub>CE</sub> =5V, I <sub>F</sub> =5mA	-	_	17	μΑ
charac-	Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	$I_F=10mA$ , $I_C=55\mu A$	-	-	0.4	V
teristics	Response time	Rise time	t <sub>r</sub>	V 5V I 100. A P 1kO	_	50	150	μs
	Response time	Fall time	t <sub>f</sub>	$V_{CE}=5V, I_{C}=100\mu A, R_{L}=1k\Omega$	-	50	150	μs

 $(T_a=25^{\circ}C)$ 

\*3 Output and coupling characteristics are common to the both phototransistors.
\*4 Characteristics except leak current is measured at θ=180°, φ=0°. Leak current is the output current of transistor when θ=+90° or -90°, φ=0° and I<sub>C</sub>=OFF.



#### ■ Absolute Maximum Ratings (Ir=5mA Vcc=5V d<+5) Device state diagram

	$\mathbf{J} = (\mathbf{I}_{\mathbf{F}} = \mathbf{J} \mathbf{I}_{\mathbf{F}} \mathbf{X}, \mathbf{V}_{\mathbf{C}} = \mathbf{J}_{\mathbf{V}}, \mathbf{\psi}_{\mathbf{S}} = \mathbf{J}_{\mathbf{V}}$										
θ	0°	$\rightarrow$	30°	$\rightarrow$	60°	Ŷ	120°	$\rightarrow$	150°	$\rightarrow$	210°
I <sub>C1</sub>	I <sub>C1</sub> OFF						In	defini	te		ON
I <sub>C2</sub>	0	FF	In	defini	te	ON				Indefinite	
θ	$\rightarrow$	240°	$\rightarrow$	300°	$\rightarrow$	330°	$\rightarrow$	360°			
L <sub>C1</sub>		ON		In	defini	ite	0	FF			

 $I_{C1}$ ON Indefinite OFF  $I_{C2}$ Indefinite OFF

I<sub>C1</sub> : Output current of phototransistors PT1

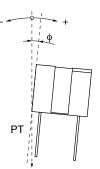
I<sub>C2</sub>: Output current of phototransistors PT2

 $\theta$ : Device condition : Refer to the figure  $\phi$ : Device condition : Refer to the figure

ON :Output current of phototransistors :  $55\mu$ A or more

OFF: Output current of phototransistors :  $17\mu A$  or less

\* Output of ON/OFF is under the condition that the device is in stationary state.

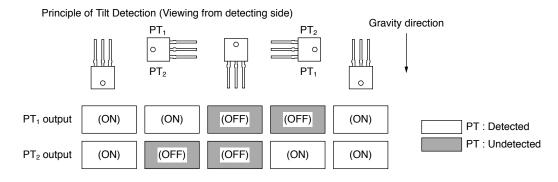


θ Ο

Gravity direction

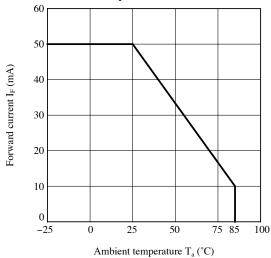
Gravity direction (Viewing from detecting side)

■ Supplement

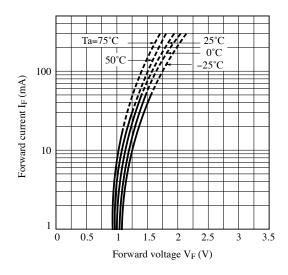








#### Fig.3 Forward Current vs. Forward Voltage



#### Fig.5 Collector Current vs. Collector-emitter Voltage

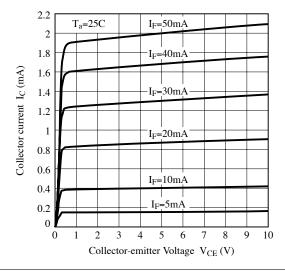
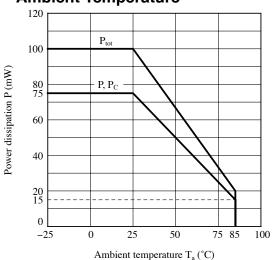
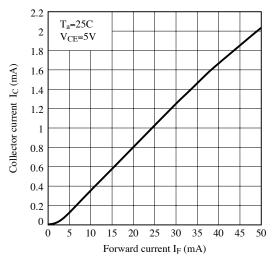


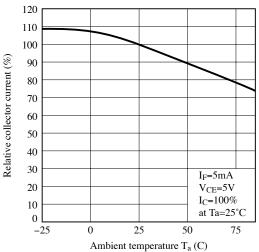
Fig.2 Power Dissipation vs. Ambient Temperature



#### Fig.4 Collector Current vs. Forward Current

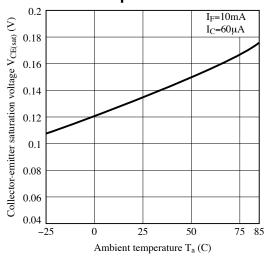








#### Fig.7 Collector-emitter Saturation Voltage vs. Ambient Temperature



#### Fig.9 Collector Dark Current vs. Ambient Temperature

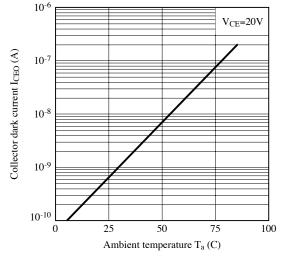
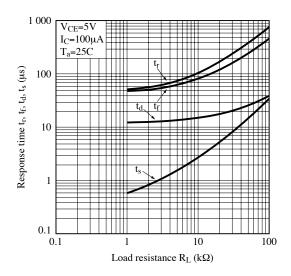
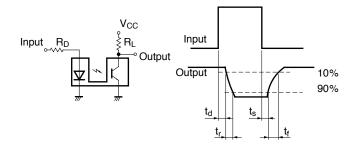


Fig.8 Response Time vs. Load Resistance



#### Fig.10 Test Circuit for Response Time



Remarks : Please be aware that all data in the graph are just for reference and not for guarantee.



#### Design Considerations

#### Design guide

1) Prevention of malfunction

To prevent photointerrupter from faulty operation caused by external light, do not set the detecting face to the external light.

Please confirm that there is no mis-operation by magnetic field in use, for prevention of mis-operation by magnetic field.

Please don't let the device put in change of temperature that makes dew for prevention of mis-operation by dew.

If the device is put in the change of temperature which makes dew, please leave the device for enough time in the constant temperature for use.

This product is not designed against irradiation and incorporates non-coherent IRED.

#### Degradation

In general, the emission of the IRED used in photointerrupter will degrade over time.

In the case of long term operation, please take the general IRED degradation (50% degradation over 5 years) into the design consideration.

#### Parts

This product is assembled using the below parts.

Photodetector (qty. : 1)

Category	Material	Maximum Sensitivity wavelength (nm)	Sensitivity wavelength (nm)	Response time (µs)	
Phototransistor	Silicon (Si)	800	700 to 1 200	12	

#### • Photo emitter (qty. : 1)

Category	Material	Maximum light emitting wavelength (nm)	I/O Frequency (MHz)
Infrared emitting diode (non-coherent)	Gallium arsenide (GaAs)	950	0.3

#### Material

Case	Lead frame	Lead frame plating	Packing case	Metal ball
Black polyphenylene sulfide resin (UL94 V-0)	42Alloy	SnCu plating	Polycarbonate	Fe



#### Manufacturing Guidelines

#### Soldering Method

Flow Soldering:

Soldering should be completed below 260°C and within 5 s.

Please solder within one time.

Soldering area is 1mm or more away from the bottom of housing.

Please take care not to let any external force exert on lead pins.

Please don't do soldering with preheating, and please don't do soldering by reflow.

#### Lead pin

Lead terminals of this product are tin copper alloy plated. Before usage, please evaluate solderability with actual conditions and confirm. And the uniformity in color for the lead terminals are not specified.

#### Other notice

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.

#### • Cleaning instructions

The device shall not be washed with washing material, for there is possibility to remain washing material in internal space of this transmissive type photointerrupter.

#### Presence of ODC

This product shall not contain the following materials. And they are not used in the production process for this product. Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

This product shall not contain the following materials banned in the RoHS Directive (2002/95/EC).
 Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBB), Polybrominated diphenyl ethers (PBDE).



#### Package specification

#### Sleeve package

Package materials Sleeve : Polystyrene Stopper : Styrene-Elastomer

Package method

MAX. 40 pcs. of products shall be packaged in a sleeve. Both ends shall be closed by tabbed and tabless stoppers.

MAX. 50 sleeves in one case.

## SHARP

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- --- Alarm equipment
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